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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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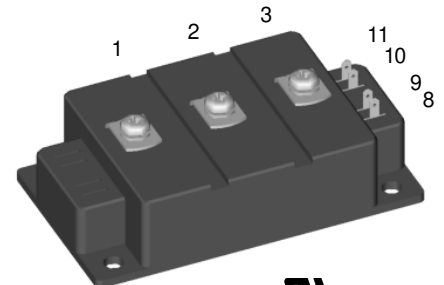
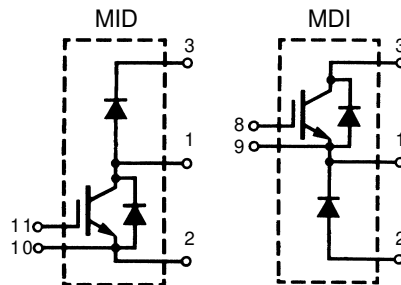


IGBT Modules

Short Circuit SOA Capability

Square RBSOA

$I_{C25} = 670 \text{ A}$
 $V_{CES} = 1200 \text{ V}$
 $V_{CE(sat) \text{ typ.}} = 2.3 \text{ V}$



E72873

Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_J = 25^\circ\text{C to } 150^\circ\text{C}$	1200	V
V_{CGR}	$T_J = 25^\circ\text{C to } 150^\circ\text{C}; R_{GE} = 20 \text{ k}\Omega$	1200	V
V_{GES}	Continuous	± 20	V
V_{GEM}	Transient	± 30	V
I_{C25}	$T_C = 25^\circ\text{C}$	670	A
I_{C80}	$T_C = 80^\circ\text{C}$	460	A
I_{CM}	$T_C = 80^\circ\text{C}, t_p = 1 \text{ ms}$ ①	920	A
t_{SC} (SCSOA)	$V_{GE} = \pm 15 \text{ V}, V_{CE} = V_{CES}, T_J = 125^\circ\text{C}$ $R_G = 1.8 \Omega$, non repetitive	10	μs
RBSOA	$V_{GE} = \pm 15 \text{ V}, T_J = 125^\circ\text{C}, R_G = 1.8 \Omega$ Clamped inductive load, $L = 100 \mu\text{H}$	$I_{CM} = 800$ $V_{CEK} \leq V_{CES}$	A
$P_{tot \text{ IGBT}}$	$T_C = 25^\circ\text{C}$	2750	W
T_J		150	$^\circ\text{C}$
T_{stg}		-40 ... +150	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $t = 1 \text{ min}$ $I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$ Insulating material: Al_2O_3	4000 4800	V~ V~
M_d	Mounting torque (module) (terminals)	2.25-2.75 20-25 2.5-3.7 22-33	Nm lb.in. Nm lb.in.
d_s	Creepage distance on surface	14	mm
d_A	Strike distance through air	9.6	mm
a	Max. allowable acceleration	50	m/s^2
Weight	Typical	250 8.8	g oz.

Data according to a single IGBT/FRED unless otherwise stated.

① Additional current limitation by external leads

Features

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes
- package with DCB ceramic base plate
- isolation voltage 4800 V
- UL registered E72873

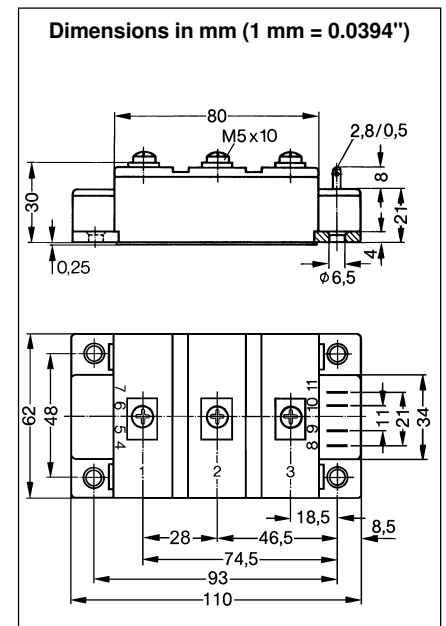
Advantages

- space and weight savings
- reduced protection circuits

Typical Applications

- AC and DC motor control
- power supplies
- welding inverters

Symbol	Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{(BR)CES}$	$V_{GE} = 0\text{ V}$	1200		V
$V_{GE(th)}$	$I_C = 16\text{ mA}$, $V_{CE} = V_{GE}$	4.5		6.5 V
I_{CES}	$V_{CE} = V_{CES}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		30	21 mA mA
I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$			1.6 μA
$V_{CE(sat)}$	$I_C = 400\text{ A}$, $V_{GE} = 15\text{ V}$	2.3		2.8 V
C_{ies}	} $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 1\text{ MHz}$		26	nF
C_{oes}			4	nF
C_{res}			2	nF
$t_{d(on)}$	} Inductive load, $T_J = 125^\circ\text{C}$ $I_C = 400\text{ A}$, $V_{GE} = \pm 15\text{ V}$ $V_{CE} = 600\text{ V}$, $R_G = 1.8\ \Omega$		100	ns
t_r			60	ns
$t_{d(off)}$			600	ns
t_f			90	ns
E_{on}			64	mJ
E_{off}			59	mJ
R_{thJC}				0.05 K/W
R_{thJS}	with heatsink compound	0.09		K/W



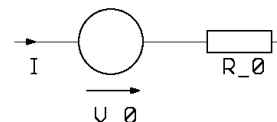
Symbol	Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
V_F	$I_F = 400\text{ A}$, $V_{GE} = 0\text{ V}$ $I_F = 400\text{ A}$, $V_{GE} = 0\text{ V}$, $T_J = 125^\circ\text{C}$		2.4 1.9	2.6 V 2.0 V
I_F	$T_C = 25^\circ\text{C}$ ① $T_C = 80^\circ\text{C}$			750 A 460 A
I_{RM}	$I_F = 400\text{ A}$, $V_{GE} = 0\text{ V}$, $-di_F/dt = 3000\text{ A}/\mu\text{s}$		300	A
t_{rr}	$T_J = 125^\circ\text{C}$, $V_R = 600\text{ V}$		200	ns
R_{thJC}				0.09 K/W
R_{thJS}		0.18		K/W

Symbol	Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
V_F	$I_F = 100\text{ A}$, $V_{GE} = 0\text{ V}$ $I_F = 100\text{ A}$, $V_{GE} = 0\text{ V}$, $T_J = 125^\circ\text{C}$		2.4 1.9	2.6 V 2.0 V
I_F	$T_C = 25^\circ\text{C}$ $T_C = 80^\circ\text{C}$			150 A 95 A
I_{RM}	$I_F = 100\text{ A}$, $V_{GE} = 0\text{ V}$, $-di_F/dt = 600\text{ A}/\mu\text{s}$		62	A
t_{rr}	$T_J = 125^\circ\text{C}$, $V_R = 600\text{ V}$		200	ns
R_{thJC}				0.45 K/W
R_{thJS}		0.9		K/W

① Additional current limitation by external leads

Equivalent Circuits for Simulation

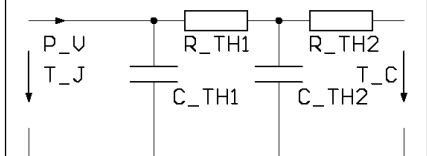
Conduction



IGBT (typ. at $V_{GE} = 15\text{ V}$; $T_J = 125^\circ\text{C}$)
 $V_0 = 1.3\text{ V}$; $R_0 = 3.2\text{ m}\Omega$

Free Wheeling Diode (typ. at $T_J = 125^\circ\text{C}$)
 $V_0 = 1.3\text{ V}$; $R_0 = 1.5\text{ m}\Omega$

Thermal Response



IGBT (typ.)
 $C_{th1} = 0.90\text{ J/K}$; $R_{th1} = 0.049\text{ K/W}$
 $C_{th2} = 2.07\text{ J/K}$; $R_{th2} = 0.001\text{ K/W}$

Free Wheeling Diode (typ.)
 $C_{th1} = 0.71\text{ J/K}$; $R_{th1} = 0.090\text{ K/W}$
 $C_{th2} = 1.30\text{ J/K}$; $R_{th2} = 0.002\text{ K/W}$

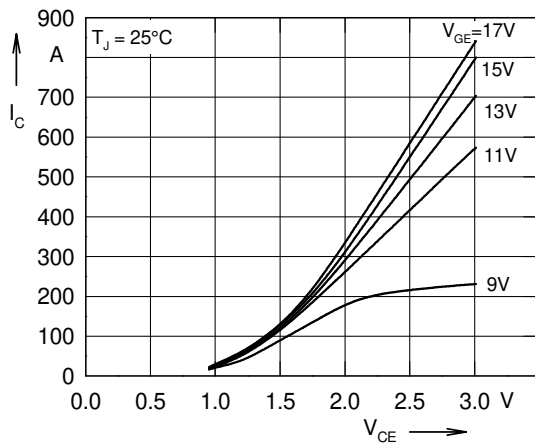


Fig. 1 Typ. output characteristics

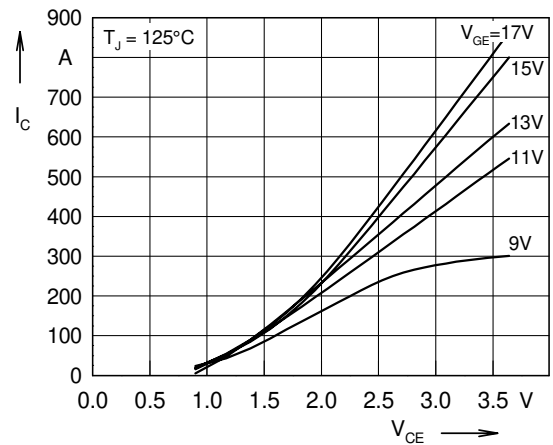


Fig. 2 Typ. output characteristics

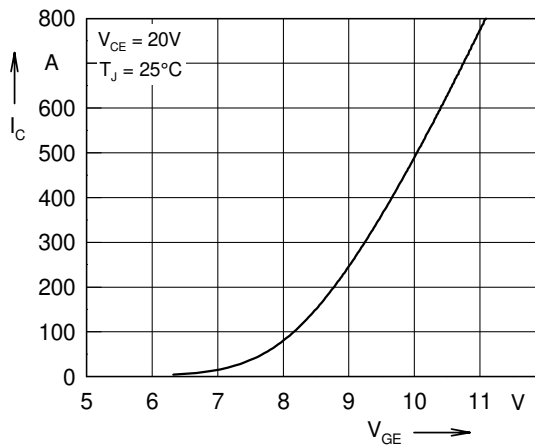


Fig. 3 Typ. transfer characteristics

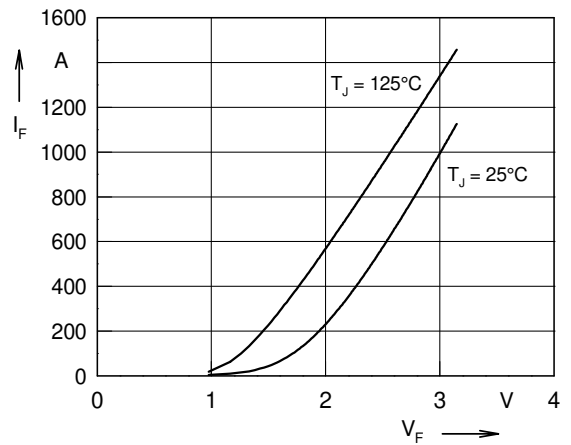


Fig. 4 Typ. forward characteristics of free wheeling diode

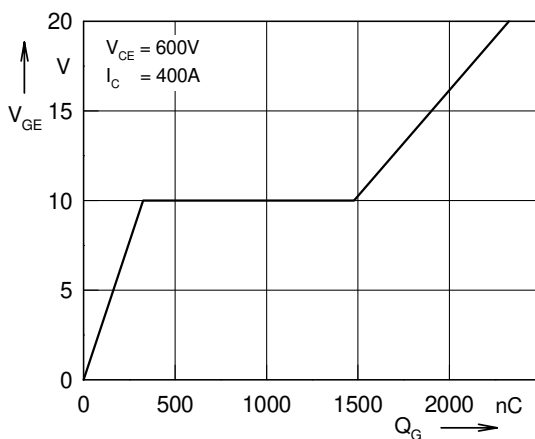


Fig. 5 Typ. turn on gate charge

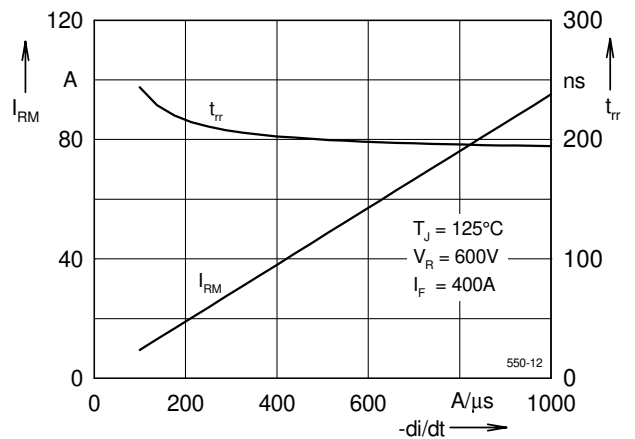


Fig. 6 Typ. turn off characteristics of free wheeling diode

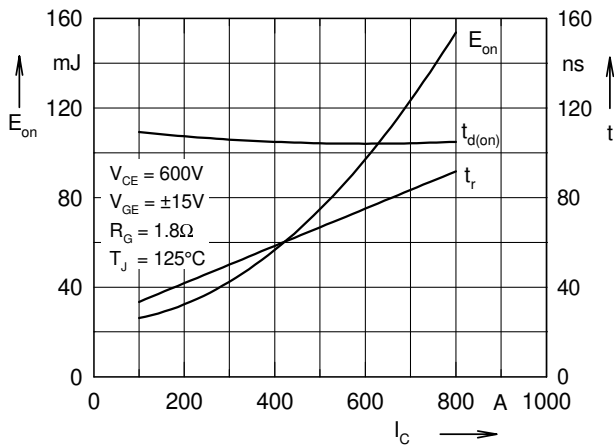


Fig. 7 Typ. turn on energy and switching times versus collector current

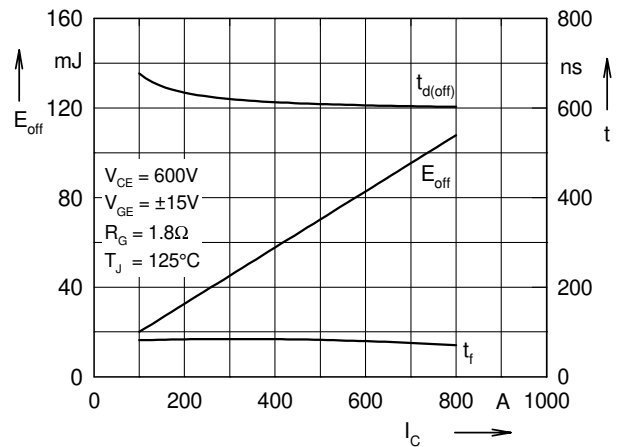


Fig. 8 Typ. turn off energy and switching times versus collector current

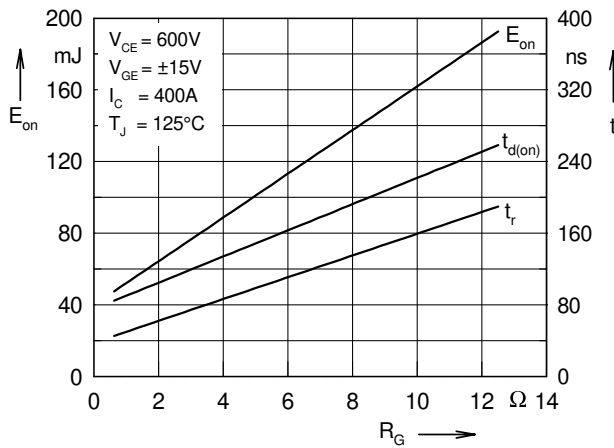


Fig. 9 Typ. turn on energy and switching times versus gate resistor

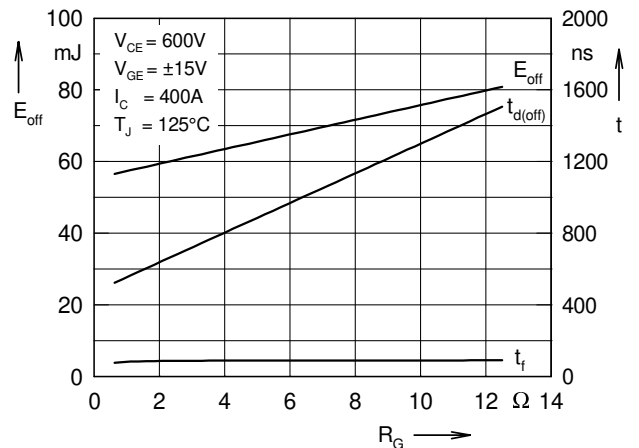


Fig.10 Typ. turn off energy and switching times versus gate resistor

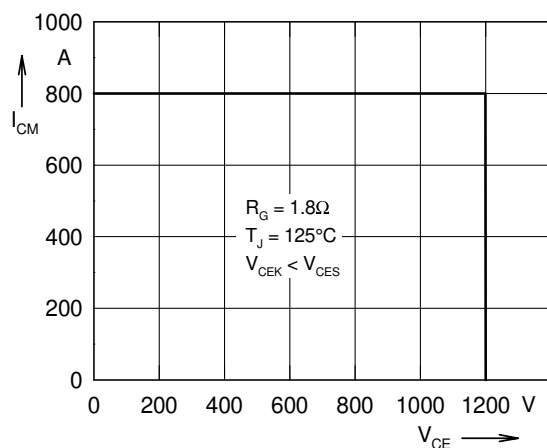


Fig. 11 Reverse biased safe operating area RBSOA

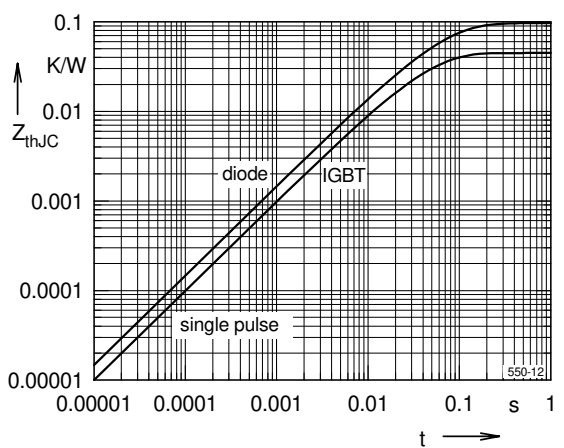


Fig. 12 Typ. transient thermal impedance